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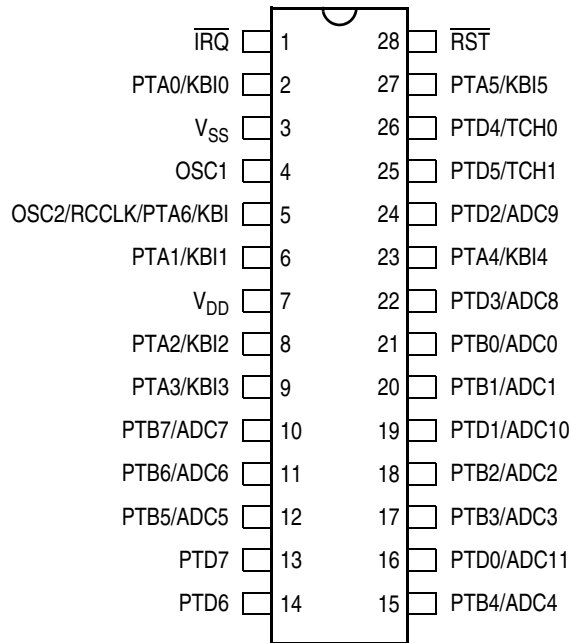
#### Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LED, LVD, POR, PWM
Number of I/O	15
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.3V
Data Converters	A/D 12x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908jk3ecdw">https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908jk3ecdw</a>



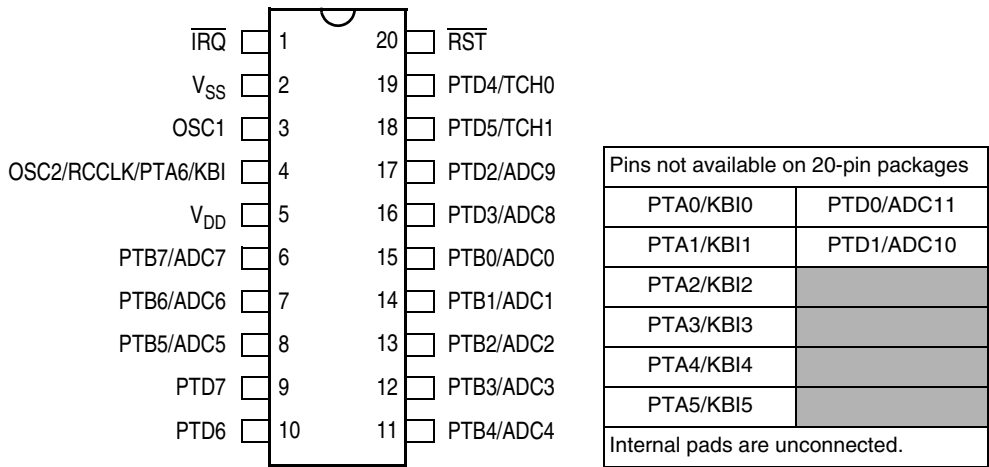
**List of Chapters**

# 1.4 Pin Assignments



**MC68H(R)C908JL3E**

**Figure 1-2. 28-Pin PDIP/SOIC Pin Assignment**



**MC68H(R)C908JK3E/JK1E**

**Figure 1-3. 20-Pin PDIP/SOIC Pin Assignment**

# Memory

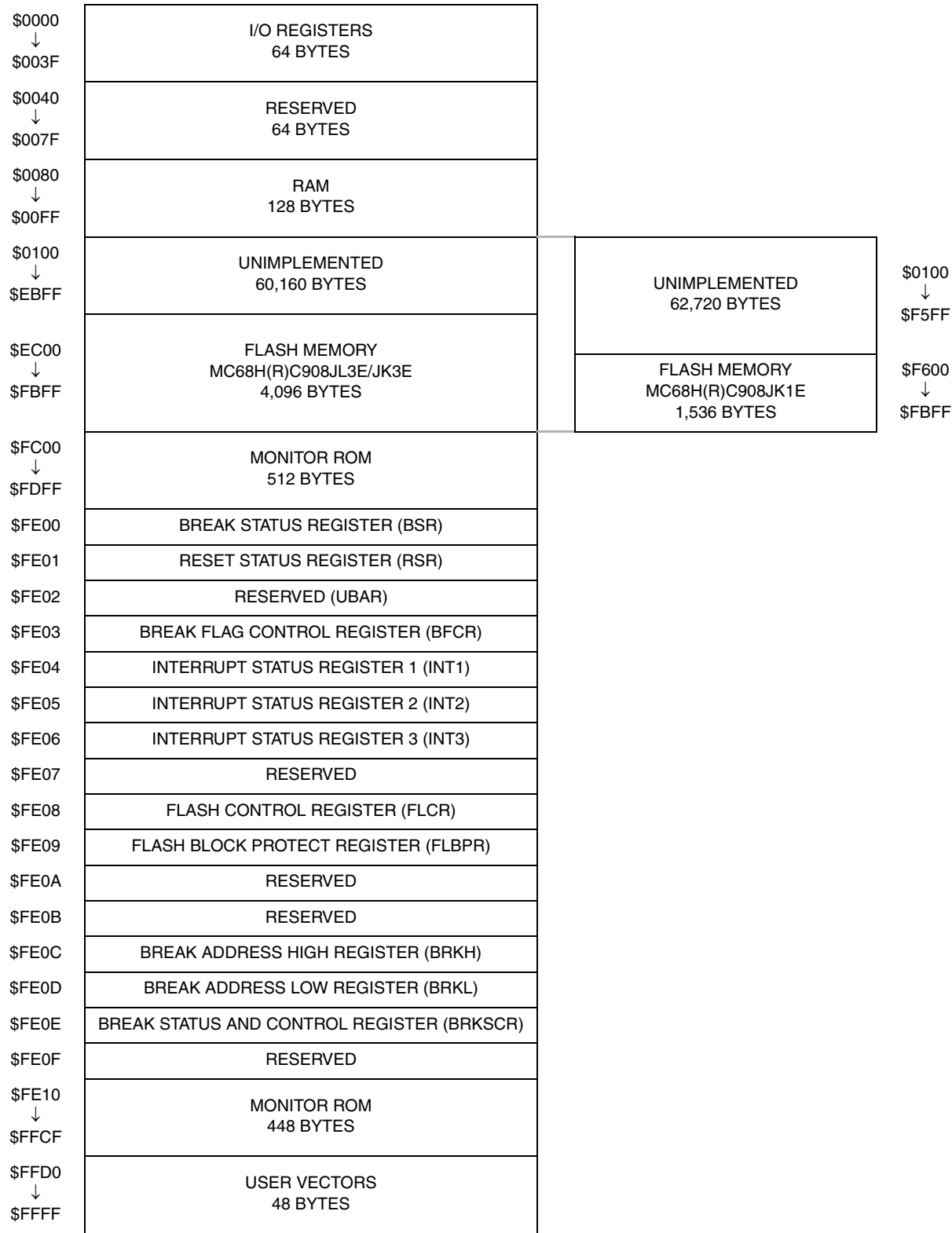


Figure 2-1. Memory Map

## Configuration Registers (CONFIG)

### LVID — Low Voltage Inhibit Disable Bit

- 1 = Low Voltage Inhibit disabled
- 0 = Low Voltage Inhibit enabled

### SSREC — Short Stop Recovery Bit

SSREC enables the CPU to exit stop mode with a delay of  $32 \times 2\text{OSCOUT}$  cycles instead of a  $4096 \times 2\text{OSCOUT}$  cycle delay.

- 1 = Stop mode recovery after  $32 \times 2\text{OSCOUT}$  cycles
- 0 = Stop mode recovery after  $4096 \times 2\text{OSCOUT}$  cycles

#### NOTE

*Exiting stop mode by pulling reset will result in the long stop recovery.*

*If using an external crystal, do not set the SSREC bit.*

### STOP — STOP Instruction Enable

STOP enables the STOP instruction.

- 1 = STOP instruction enabled
- 0 = STOP instruction treated as illegal opcode

### COPD — COP Disable Bit

COPD disables the COP module. (See Chapter 13 Computer Operating Properly (COP).)

- 1 = COP module disabled
- 0 = COP module enabled

## 3.4 Configuration Register 2 (CONFIG2)

Address:	\$001E							
	Bit 7	6	5	4	3	2	1	Bit 0
Read:	IRQPUD	R	R	LVIT1	LVIT0	R	R	R
Write:								
Reset:	0	0	0	Not affected	Not affected	0	0	0
POR:	0	0	0	0	0	0	0	0
	<div style="border: 1px solid black; padding: 2px; display: inline-block;">R</div> = Reserved							

**Figure 3-2. Configuration Register 2 (CONFIG2)**

### IRQPUD — $\overline{\text{IRQ}}$ Pin Pull-up control bit

- 1 = Internal pull-up is disconnected
- 0 = Internal pull-up is connected between  $\overline{\text{IRQ}}$  pin and  $V_{DD}$

### LVIT1, LVIT0 — Low Voltage Inhibit trip voltage selection bits

Detail description of the LVI control signals is given in Chapter 14 Low Voltage Inhibit (LVI)

## Chapter 4

# Central Processor Unit (CPU)

### 4.1 Introduction

The M68HC08 CPU (central processor unit) is an enhanced and fully object-code-compatible version of the M68HC05 CPU. The *CPU08 Reference Manual* (document order number CPU08RM/AD) contains a description of the CPU instruction set, addressing modes, and architecture.

### 4.2 Features

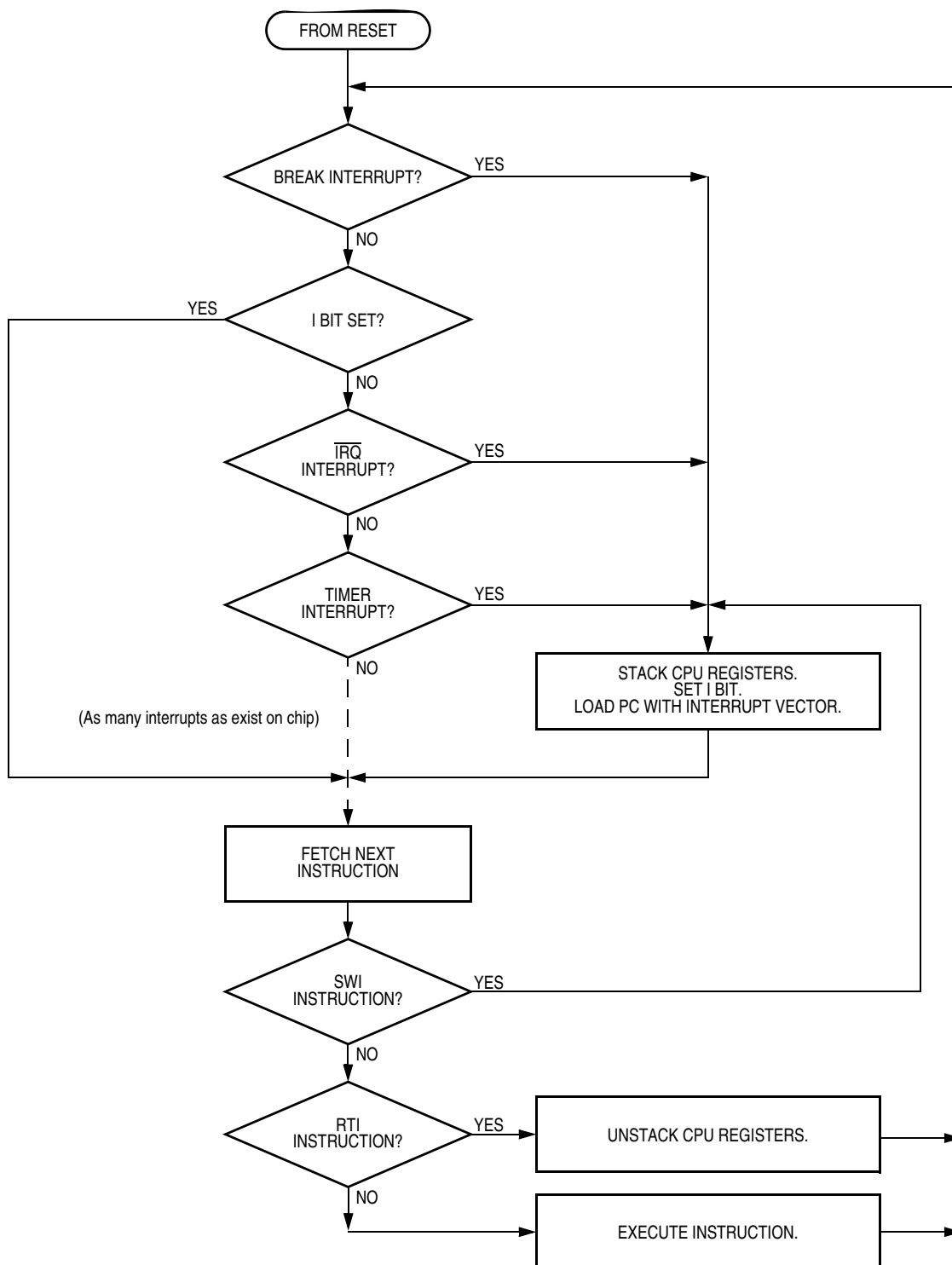
Features of the CPU include:

- Object code fully upward-compatible with M68HC05 Family
- 16-bit stack pointer with stack manipulation instructions
- 16-bit index register with x-register manipulation instructions
- 8-MHz CPU internal bus frequency
- 64-Kbyte program/data memory space
- 16 addressing modes
- Memory-to-memory data moves without using accumulator
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- Enhanced binary-coded decimal (BCD) data handling
- Modular architecture with expandable internal bus definition for extension of addressing range beyond 64 Kbytes
- Low-power stop and wait modes

### 4.3 CPU Registers

Figure 4-1 shows the five CPU registers. CPU registers are not part of the memory map.

Interrupts are latched, and arbitration is performed in the SIM at the start of interrupt processing. The arbitration result is a constant that the CPU uses to determine which vector to fetch. Once an interrupt is latched by the SIM, no other interrupt can take precedence, regardless of priority, until the latched interrupt is serviced (or the I bit is cleared).



**Figure 5-8. Interrupt Processing**

## 6.5 Low Power Modes

The WAIT and STOP instructions put the MCU in low-power consumption standby modes.

### 6.5.1 Wait Mode

The WAIT instruction has no effect on the oscillator logic. OSCOUT and 2OSCOUT continues to drive to the SIM module.

### 6.5.2 Stop Mode

The STOP instruction disables the XTALCLK or the RCCLK output, hence OSCOUT and 2OSCOUT.

## 6.6 Oscillator During Break Mode

The oscillator continues to drive OSCOUT and 2OSCOUT when the device enters the break state.



### 7.3.1 Entering Monitor Mode

Table 7-1 shows the pin conditions for entering monitor mode. As specified in the table, monitor mode may be entered after a POR and will allow communication at 9600 baud provided one of the following sets of conditions is met:

1. If  $\overline{\text{IRQ}} = V_{\text{TST}}$ :
  - Clock on OSC1 is 4.9125MHz (EXT OSC or XTAL)
  - PTB3 = low
2. If  $\overline{\text{IRQ}} = V_{\text{TST}}$ :
  - Clock on OSC1 is 9.8304MHz (EXT OSC or XTAL)
  - PTB3 = high
3. If \$FFFE & \$FFFF is blank (contains \$FF):
  - Clock on OSC1 is 9.8304MHz (EXT OSC or XTAL or RC)
  - $\overline{\text{IRQ}} = V_{\text{DD}}$

**Table 7-1. Monitor Mode Entry Requirements and Options**

$\overline{\text{IRQ}}$	\$FFFE and \$FFFF	PTB3 <sup>(1)</sup>	PTB2	PTB1	PTB0	OSC1 Frequency	Bus Frequency	Comments
$V_{\text{TST}}^{(2)}$	X	0	0	1	1	4.9152MHz	2.4576MHz (OSC1 ÷ 2)	High-voltage entry to monitor mode. <sup>(3)</sup>
$V_{\text{TST}}$	X	1	0	1	1	9.8304MHz	2.4576MHz (OSC1 ÷ 4)	9600 baud communication on PTB0. COP disabled.
$V_{\text{DD}}$	BLANK (contain \$FF)	X	X	X	1	9.8304MHz	2.4576MHz (OSC1 ÷ 4)	Low-voltage entry to monitor mode. <sup>(4)</sup>
$V_{\text{DD}}$	NOT BLANK	X	X	X	X	At desired frequency	OSC1 ÷ 4	Enters User mode.

1. PTB3 = 0: Bypasses the divide-by-two prescaler to SIM when using  $V_{\text{TST}}$  for monitor mode entry. The OSC1 clock must be 50% duty cycle for this condition.
2. See Table 16-4. DC Electrical Characteristics (5V) for  $V_{\text{TST}}$  voltage level requirements.
3. For  $\overline{\text{IRQ}} = V_{\text{TST}}$ :
  - MC68HRC908JL3E/JK3E/JK1E — clock must be EXT OSC.
  - MC68HC908JL3E/JK3E/JK1E — clock can be EXT OSC or XTAL.
4. For  $\overline{\text{IRQ}} = V_{\text{DD}}$ :
  - MC68HRC908JL3E/JK3E/JK1E — clock must be RC OSC.
  - MC68HC908JL3E/JK3E/JK1E — clock can be EXT OSC or XTAL.

If  $V_{\text{TST}}$  is applied to  $\overline{\text{IRQ}}$  and PTB3 is low upon monitor mode entry (Table 7-1 condition set 1), the bus frequency is a divide-by-two of the clock input to OSC1. If PTB3 is high with  $V_{\text{TST}}$  applied to  $\overline{\text{IRQ}}$  upon monitor mode entry (Table 7-1 condition set 2), the bus frequency is a divide-by-four of the clock input to OSC1. Holding the PTB3 pin low when entering monitor mode causes a bypass of a divide-by-two stage at the oscillator *only if  $V_{\text{TST}}$  is applied to  $\overline{\text{IRQ}}$* . In this event, the OSCOUT frequency is equal to the 2OSCOUT frequency, and OSC1 input directly generates internal bus clocks. In this case, the OSC1 signal must have a 50% duty cycle at maximum bus frequency.

**Table 7-8. READSP (Read Stack Pointer) Command**

Description	Reads stack pointer
Operand	None
Data Returned	Returns stack pointer in high byte:low byte order
Opcode	\$0C
<p>Command Sequence</p>	

**Table 7-9. RUN (Run User Program) Command**

Description	Executes RTI instruction
Operand	None
Data Returned	None
Opcode	\$28
<p>Command Sequence</p>	

## 7.4 Security

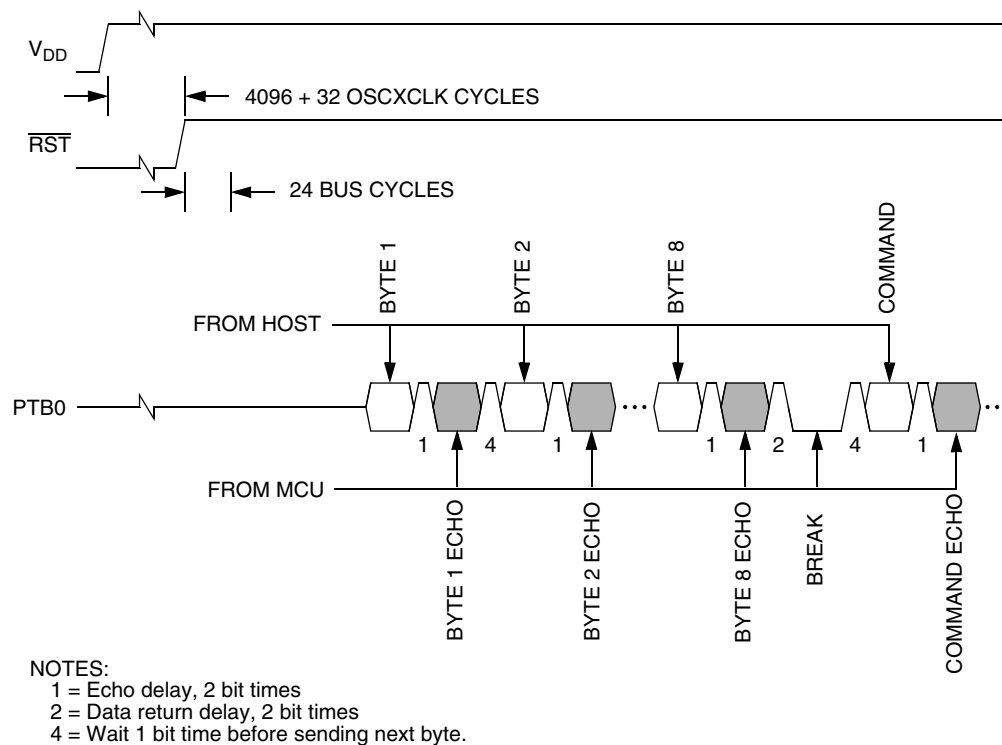
A security feature discourages unauthorized reading of Flash locations while in monitor mode. The host can bypass the security feature at monitor mode entry by sending eight security bytes that match the bytes at locations \$FFF6–\$FFFD. Locations \$FFF6–\$FFFD contain user-defined data.

### NOTE

*Do not leave locations \$FFF6–\$FFFD blank. For security reasons, program locations \$FFF6–\$FFFD even if they are not used for vectors.*

During monitor mode entry, the MCU waits after the power-on reset for the host to send the eight security bytes on pin PTB0. If the received bytes match those at locations \$FFF6–\$FFFD, the host bypasses the security feature and can read all Flash locations and execute code from Flash. Security remains bypassed until a power-on reset occurs. If the reset was not a power-on reset, security remains bypassed and security code entry is not required. (See Figure 7-7.)

## Monitor ROM (MON)



**Figure 7-7. Monitor Mode Entry Timing**

Upon power-on reset, if the received bytes of the security code do not match the data at locations \$FFF6–\$FFFD, the host fails to bypass the security feature. The MCU remains in monitor mode, but reading a Flash location returns an invalid value and trying to execute code from Flash causes an illegal address reset. After receiving the eight security bytes from the host, the MCU transmits a break character, signifying that it is ready to receive a command.

### NOTE

*The MCU does not transmit a break character until after the host sends the eight security bytes.*

To determine whether the security code entered is correct, check to see if bit 6 of RAM address \$80 is set. If it is, then the correct security code has been entered and Flash can be accessed.

If the security sequence fails, the device should be reset by a power-on reset and brought up in monitor mode to attempt another entry. After failing the security sequence, the Flash module can also be mass erased by executing an erase routine that was downloaded into internal RAM. The mass erase operation clears the security code locations so that all eight security bytes become \$FF (blank).

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$0020	TIM Status and Control Register (TSC)	Read:	TOF	TOIE	TSTOP	0	0	PS2	PS1	PS0
		Write:	0			TRST				
		Reset:	0	0	1	0	0	0	0	0
\$0021	TIM Counter Register High (TCNTH)	Read:	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0022	TIM Counter Register Low (TCNTL)	Read:	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$0023	TIM Counter Modulo Register High (TMODH)	Read:	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8
		Write:								
		Reset:	1	1	1	1	1	1	1	1
\$0024	TIM Counter Modulo Register Low (TMDL)	Read:	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
		Write:								
		Reset:	1	1	1	1	1	1	1	1
\$0025	TIM Channel 0 Status and Control Register (TSC0)	Read:	CH0F	CH0IE	MS0B	MS0A	ELS0B	ELS0A	TOV0	CH0MAX
		Write:	0							
		Reset:	0	0	0	0	0	0	0	0
\$0026	TIM Channel 0 Register High (TCH0H)	Read:	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8
		Write:								
		Reset:	Indeterminate after reset							
\$0027	TIM Channel 0 Register Low (TCH0L)	Read:	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
		Write:								
		Reset:	Indeterminate after reset							
\$0028	TIM Channel 1 Status and Control Register (TSC1)	Read:	CH1F	CH1IE	0	MS1A	ELS1B	ELS1A	TOV1	CH1MAX
		Write:	0							
		Reset:	0	0	0	0	0	0	0	0
\$0029	TIM Channel 1 Register High (TCH1H)	Read:	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8
		Write:								
		Reset:	Indeterminate after reset							
\$002A	TIM Channel 1 Register Low (TCH1L)	Read:	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
		Write:								
		Reset:	Indeterminate after reset							
				= Unimplemented						

**Figure 8-2. TIM I/O Register Summary**

### 8.4.4.3 PWM Initialization

To ensure correct operation when generating unbuffered or buffered PWM signals, use the following initialization procedure:

1. In the TIM status and control register (TSC):
  - a. Stop the TIM counter by setting the TIM stop bit, TSTOP.
  - b. Reset the TIM counter and prescaler by setting the TIM reset bit, TRST.
2. In the TIM counter modulo registers (TMODH:TMODL), write the value for the required PWM period.
3. In the TIM channel x registers (TCHxH:TCHxL), write the value for the required pulse width.
4. In TIM channel x status and control register (TSCx):
  - a. Write 0:1 (for unbuffered output compare or PWM signals) or 1:0 (for buffered output compare or PWM signals) to the mode select bits, MSxB:MSxA. (See Table 8-3.)
  - b. Write 1 to the toggle-on-overflow bit, TOVx.
  - c. Write 1:0 (to clear output on compare) or 1:1 (to set output on compare) to the edge/level select bits, ELSxB:ELSxA. The output action on compare must force the output to the complement of the pulse width level. (See Table 8-3.)

#### NOTE

*In PWM signal generation, do not program the PWM channel to toggle on output compare. Toggling on output compare prevents reliable 0% duty cycle generation and removes the ability of the channel to self-correct in the event of software error or noise. Toggling on output compare can also cause incorrect PWM signal generation when changing the PWM pulse width to a new, much larger value.*

5. In the TIM status control register (TSC), clear the TIM stop bit, TSTOP.

Setting MS0B links channels 0 and 1 and configures them for buffered PWM operation. The TIM channel 0 registers (TCH0H:TCH0L) initially control the buffered PWM output. TIM status control register 0 (TSC0) controls and monitors the PWM signal from the linked channels. MS0B takes priority over MS0A.

Clearing the toggle-on-overflow bit, TOVx, inhibits output toggles on TIM overflows. Subsequent output compares try to force the output to a state it is already in and have no effect. The result is a 0% duty cycle output.

Setting the channel x maximum duty cycle bit (CHxMAX) and setting the TOVx bit generates a 100% duty cycle output. (See 8.9.4 TIM Channel Status and Control Registers (TSC0:TSC1).)

# Chapter 9

## Analog-to-Digital Converter (ADC)

### 9.1 Introduction


This section describes the 12-channel, 8-bit linear successive approximation analog-to-digital converter (ADC).

### 9.2 Features

Features of the ADC module include:

- 12 channels with multiplexed input
- Linear successive approximation with monotonicity
- 8-bit resolution
- Single or continuous conversion
- Conversion complete flag or conversion complete interrupt
- Selectable ADC clock

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$003C	ADC Status and Control Register (ADSCR)	Read:	COCO	AIEN	ADCO	ADCH4	ADCH3	ADCH2	ADCH1	ADCH0
		Write:								
		Reset:	0	0	0	1	1	1	1	1
\$003D	ADC Data Register (ADR)	Read:	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
		Write:								
		Reset:	Indeterminate after reset							
\$003E	ADC Input Clock Register (ADICLK)	Read:	ADIV2	ADIV1	ADIV0	0	0	0	0	0
		Write:								
		Reset:	0	0	0	0	0	0	0	0

 = Unimplemented

**Figure 9-1. ADC I/O Register Summary**

### 9.3 Functional Description

Twelve ADC channels are available for sampling external sources at pins PTB0–PTB7 and PTD0–PTD3. An analog multiplexer allows the single ADC converter to select one of the 12 ADC channels as ADC voltage input (ADCVIN). ADCVIN is converted by the successive approximation register-based counters. The ADC resolution is 8 bits. When the conversion is completed, ADC puts the result in the ADC data register and sets a flag or generates an interrupt. Figure 9-2 shows a block diagram of the ADC.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge-sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt pin stays at 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.

To determine the logic level on a keyboard interrupt pin, disable the pull-up device, use the data direction register to configure the pin as an input and then read the data register.

#### NOTE

*Setting a keyboard interrupt enable bit (KBIE<sub>x</sub>) forces the corresponding keyboard interrupt pin to be an input, overriding the data direction register. However, the data direction register bit must be a 0 for software to read the pin.*

### 12.4.1 Keyboard Initialization

When a keyboard interrupt pin is enabled, it takes time for the internal pull-up to reach a logic 1. Therefore a false interrupt can occur as soon as the pin is enabled.

To prevent a false interrupt on keyboard initialization:

1. Mask keyboard interrupts by setting the IMASKK bit in the keyboard status and control register.
2. Enable the KBI pins by setting the appropriate KBIE<sub>x</sub> bits in the keyboard interrupt enable register.
3. Write to the ACKK bit in the keyboard status and control register to clear any false interrupts.
4. Clear the IMASKK bit.

An interrupt signal on an edge-triggered pin can be acknowledged immediately after enabling the pin. An interrupt signal on an edge- and level-triggered interrupt pin must be acknowledged after a delay that depends on the external load.

Another way to avoid a false interrupt:

1. Configure the keyboard pins as outputs by setting the appropriate DDRA bits in the data direction register A.
2. Write 1s to the appropriate port A data register bits.
3. Enable the KBI pins by setting the appropriate KBIE<sub>x</sub> bits in the keyboard interrupt enable register.

## 12.5 Keyboard Interrupt Registers

Two registers control the operation of the keyboard interrupt module:

- Keyboard status and control register
- Keyboard interrupt enable register

### 13.7.1 Wait Mode

The COP continues to operate during wait mode. To prevent a COP reset during wait mode, periodically clear the COP counter in a CPU interrupt routine.

### 13.7.2 Stop Mode

Stop mode turns off the 2OSCOUT input to the COP and clears the SIM counter. Service the COP immediately before entering or after exiting stop mode to ensure a full COP timeout period after entering or exiting stop mode.

## 13.8 COP Module During Break Mode

The COP is disabled during a break interrupt when  $V_{TST}$  is present on the  $\overline{RST}$  pin.



## 14.4 LVI Control Register (CONFIG2/CONFIG1)

The LVI module is controlled by three bits in the configuration registers, CONFIG1 and CONFIG2.

Address: \$001E

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	IRQPUD	R	R	LVIT1	LVIT0	R	R	R
Write:								
Reset:	0	0	0	Not affected	Not affected	0	0	0
POR:	0	0	0	0	0	0	0	0

R = Reserved

**Figure 14-2. Configuration Register 2 (CONFIG2)**

Address: \$001F

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	COPRS	R	R	LVID	R	SSREC	STOP	COPD
Write:								
Reset:	0	0	0	0	0	0	0	0

R = Reserved

**Figure 14-3. Configuration Register 1 (CONFIG1)**

### LVID — Low Voltage Inhibit Disable Bit

1 = Low voltage inhibit disabled

0 = Low voltage inhibit enabled

### LVIT1, LVIT0 — LVI Trip Voltage Selection

These two bits determine at which level of  $V_{DD}$  the LVI module will come into action. LVIT1 and LVIT0 are cleared by a Power-On Reset only.

LVIT1	LVIT0	Trip Voltage <sup>(1)</sup>	Comments
0	0	$V_{LVR3}$ (2.4V)	For $V_{DD}=3V$ operation
0	1	$V_{LVR3}$ (2.4V)	For $V_{DD}=3V$ operation
1	0	$V_{LVR5}$ (4.0V)	For $V_{DD}=5V$ operation
1	1	Reserved	

1. See Chapter 16 Electrical Specifications for full parameters.

## 14.5 Low-Power Modes

The STOP and WAIT instructions put the MCU in low-power-consumption standby modes.

### 14.5.1 Wait Mode

The LVI module, when enabled, will continue to operate in WAIT Mode.

### 14.5.2 Stop Mode

The LVI module, when enabled, will continue to operate in STOP Mode.

## Break Module (BREAK)

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$FE00	Break Status Register (BSR)	Read:	R	R	R	R	R	R	SBSW	R
		Write:							See note	
		Reset:	0							
\$FE03	Break Flag Control Register (BFCR)	Read:	BCFE	R	R	R	R	R	R	R
		Write:								
		Reset:	0							
\$FE0C	Break Address High Register (BRKH)	Read:	Bit15	Bit14	Bit13	Bit12	Bit11	Bit10	Bit9	Bit8
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$FE0D	Break Address low Register (BRKL)	Read:	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$FE0E	Break Status and Control Register (BRKSCR)	Read:	BRKE	BRKA	0	0	0	0	0	0
		Write:								
		Reset:	0	0	0	0	0	0	0	0

Note: Writing a 0 clears SBSW.

  = Unimplemented      R = Reserved

**Figure 15-2. Break I/O Register Summary**

### 15.3.1 Flag Protection During Break Interrupts

The system integration module (SIM) controls whether or not module status bits can be cleared during the break state. The BCFE bit in the break flag control register (BFCR) enables software to clear status bits during the break state. (See 5.7.3 Break Flag Control Register (BFCR) and see the Break Interrupts subsection for each module.)

### 15.3.2 CPU During Break Interrupts

The CPU starts a break interrupt by:

- Loading the instruction register with the SWI instruction
- Loading the program counter with \$FFFC:\$FFFD (\$FEFC:\$FEFD in monitor mode)

The break interrupt begins after completion of the CPU instruction in progress. If the break address register match occurs on the last cycle of a CPU instruction, the break interrupt begins immediately.

### 15.3.3 TIM During Break Interrupts

A break interrupt stops the timer counter.

### 15.3.4 COP During Break Interrupts

The COP is disabled during a break interrupt when  $V_{TST}$  is present on the  $\overline{RST}$  pin.

## 15.4 Break Module Registers

These registers control and monitor operation of the break module:


- Break status and control register (BRKSCR)
- Break address register high (BRKH)
- Break address register low (BRKL)
- Break status register (BSR)
- Break flag control register (BFCR)

### 15.4.1 Break Status and Control Register (BRKSCR)

The break status and control register contains break module enable and status bits.

Address: \$FE0E

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	BRKE	BRKA	0	0	0	0	0	0
Write:								
Reset:	0	0	0	0	0	0	0	0

 = Unimplemented

**Figure 15-3. Break Status and Control Register (BRKSCR)**

#### BRKE — Break Enable Bit

This read/write bit enables breaks on break address register matches. Clear BRKE by writing a zero to bit 7. Reset clears the BRKE bit.

- 1 = Breaks enabled on 16-bit address match
- 0 = Breaks disabled

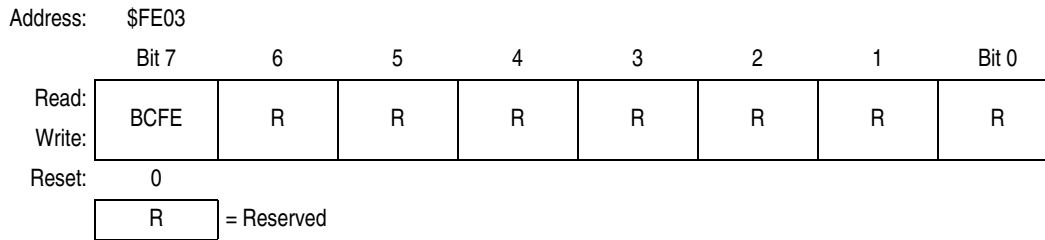
#### BRKA — Break Active Bit

This read/write status and control bit is set when a break address match occurs. Writing a one to BRKA generates a break interrupt. Clear BRKA by writing a zero to it before exiting the break routine. Reset clears the BRKA bit.

- 1 = Break address match
- 0 = No break address match

### 15.4.4 Break Flag Control Register (BFCR)

The break control register contains a bit that enables software to clear status bits while the MCU is in a break state.



**Figure 15-7. Break Flag Control Register (BFCR)**

#### BCFE — Break Clear Flag Enable Bit

This read/write bit enables software to clear status bits by accessing status registers while the MCU is in a break state. To clear status bits during the break state, the BCFE bit must be set.

- 1 = Status bits clearable during break
- 0 = Status bits not clearable during break

## 15.5 Low-Power Modes

The WAIT and STOP instructions put the MCU in low-power-consumption standby modes.

### 15.5.1 Wait Mode

If enabled, the break module is active in wait mode. In the break routine, the user can subtract one from the return address on the stack if SBSW is set (see 5.6 Low-Power Modes). Clear the SBSW bit by writing zero to it.

### 15.5.2 Stop Mode

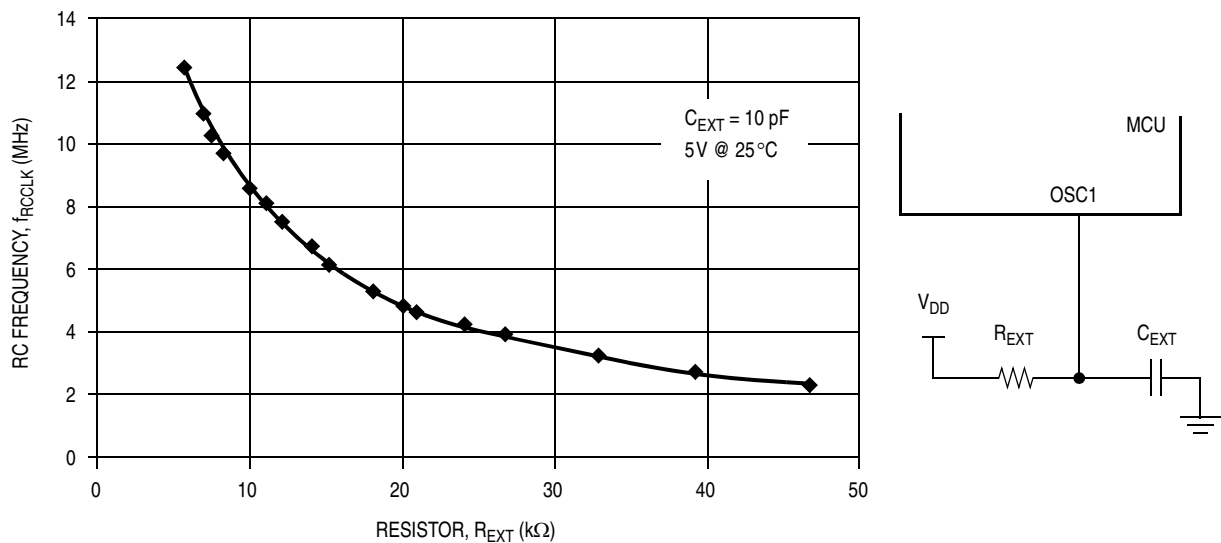
A break interrupt causes exit from stop mode and sets the SBSW bit in the break status register. See 5.7 SIM Registers.

## 16.7 5V Oscillator Characteristics

**Table 16-6. Oscillator Component Specifications (5V)**

Characteristic	Symbol	Min	Typ	Max	Unit
Crystal frequency, XTALCLK	$f_{\text{OSCCLK}}$	—	10	32	MHz
RC oscillator frequency, RCCLK	$f_{\text{RCCLK}}$	2	10	12	MHz
External clock reference frequency <sup>(1)</sup>	$f_{\text{OSCCLK}}$	dc	—	32	MHz
Crystal load capacitance <sup>(2)</sup>	$C_L$	—	—	—	
Crystal fixed capacitance <sup>(2)</sup>	$C_1$	—	$2 \times C_L$	—	
Crystal tuning capacitance <sup>(2)</sup>	$C_2$	—	$2 \times C_L$	—	
Feedback bias resistor	$R_B$	—	10 M $\Omega$	—	
Series resistor <sup>(2), (3)</sup>	$R_S$	—	—	—	
RC oscillator external R	$R_{\text{EXT}}$	See Figure 16-1			
RC oscillator external C	$C_{\text{EXT}}$	—	10	—	pF

1. No more than 10% duty cycle deviation from 50%.
2. Consult crystal vendor data sheet.
3. Not required for high frequency crystals.



**Figure 16-1. RC vs. Frequency (5V @ 25°C)**